

Description

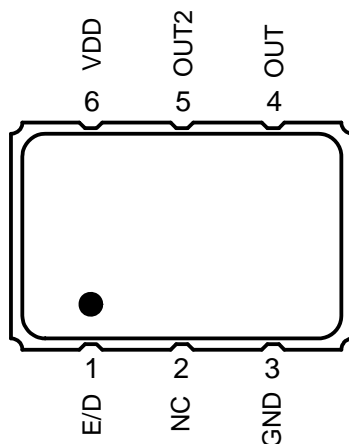
The XLP is an LVPECL crystal oscillator with 860fs typical phase jitter over 12kHz to 20MHz bandwidth. Available in a wide frequency range from 0.750MHz to 1350MHz, the IDT XLP series crystal oscillator utilizes a family of proprietary ASICs, with a key focus on noise reduction technologies.

The 3rd order Delta Sigma Modulator reduces noise to the levels that are comparable to traditional bulk Quartz and SAW oscillators. With short lead-time, low cost, low noise, wide frequency range, excellent ambient performance, the XLP is an excellent choice over the conventional technologies. The XLP has stabilities as tight as $\pm 20\text{ppm}$ with extremely quick delivery for both standard and custom frequencies

Features

- Frequency range: 0.750 to 1350MHz
- Output type: LVPECL
- Frequency stability: $\pm 20\text{ppm}$, $\pm 25\text{ppm}$, $\pm 50\text{ppm}$, or $\pm 100\text{ppm}$
- Supply voltage: 2.5V or 3.3V
- Phase jitter (1.875MHz to 20MHz): 225fs typical
- Phase jitter (12kHz to 20MHz): 860fs typical
- Package options: 5.0mm x 3.2mm x 1.2mm (JS6)
7.0mm x 5.0mm x 1.3mm (JU6)
- Operating temperatures: -20°C to $+70^{\circ}\text{C}$ or -40°C to $+85^{\circ}\text{C}$

Pin Assignment



6-pin CLCC

Pin Descriptions

Pin Number	Pin Name	Description
1	E/D	Enable/Disable ¹ (0=Output Disabled)
2	NC	No connect
3	GND	Connect to ground
4	OUT	Output
5	OUT2	Complementary Output
6	VDD	Supply voltage

1. Pulled high internally.

Absolute Maximum Ratings

Stresses above the ratings listed below can cause permanent damage to the XLP. These ratings, which are standard values for IDT commercially rated parts, are stress ratings only. Functional operation of the device at these or any other conditions above those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods can affect product reliability. Electrical parameters are guaranteed only over the recommended operating temperature range.

Item	Rating
VDD	-0.5 to +5.0V
E/D	-0.5V to VDD + 0.5V
OUT	-0.5V to VDD + 0.5V
Storage Temperature	-55°C to 125°C
Theta Ja (Junction to Ambient)	102°C/W – Still Air

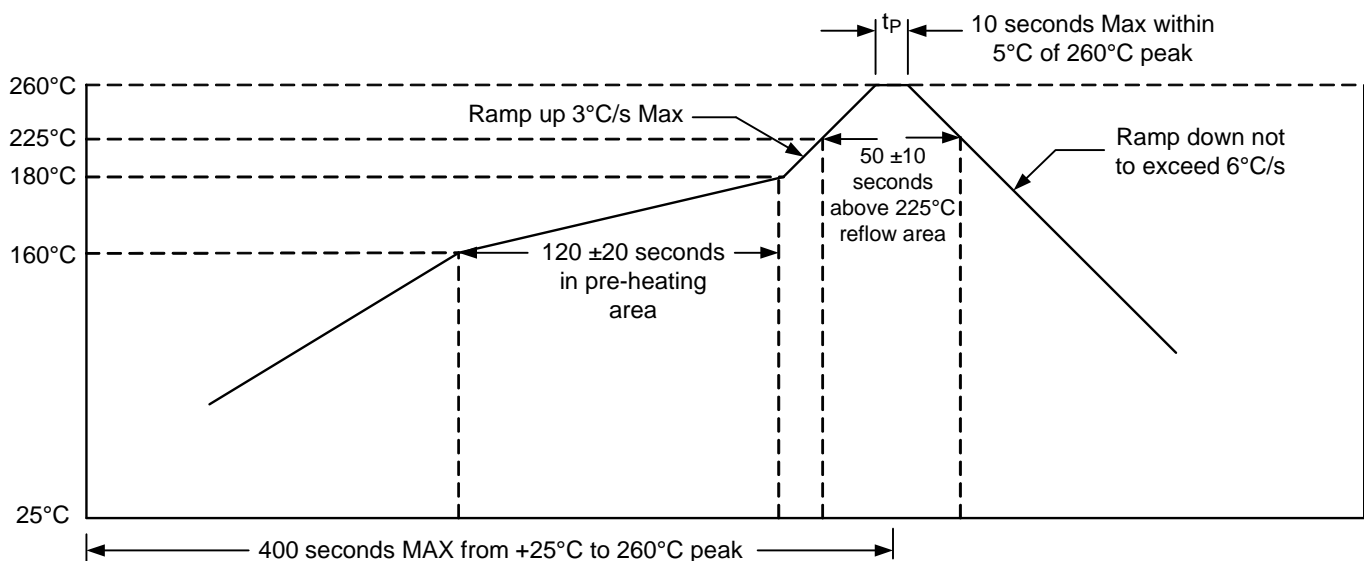
ESD Compliance

Human Body Model (HBM)	1000V
Machine Model (MM)	150V

Mechanical Testing

Parameter	Test Method
Mechanical Shock	Drop from 75cm to hardwood surface–3 times
Mechanical Vibration	10~55Hz, 1.5mm amplitude, 1 minute sweep 2 hours each in 3 directions (X, Y, Z)
High Temperature Burn-in	Under power at 125°C for 2000 hours
Hermetic Seal	He pressure: $4 \pm 1 \text{kgf/cm}^2$ 2 hour soak

Solder Reflow Profile



DC Characteristics

($V_{DD} = 3.3V \pm 5\%$, $T_A = -20^\circ C$ to $+70^\circ C$; -40° to $+85^\circ C$)

Parameter	Symbol	Condition	Min	Typ	Max	Units
Power Supply Current	I_{DD}	Common Frequencies			120	mA
Output HIGH Voltage	V_{OH}	Standard LVPECL load	2.055		2.405	V
Output LOW Voltage	V_{OL}	Standard LVPECL load	1.305		1.650	V
Enable/Disable Input HIGH Voltage (Output enabled)*	V_{IH}		$70\%V_{DD}$			V
Enable/Disable Input LOW Voltage (Output disabled)	V_{IL}				$30\%V_{DD}$	V

* A pullup resistor from pin 6 (VDD) to pin 1 (E/D) enables output when pin 1 is left open.

AC Characteristics

($V_{DD} = 3.3V \pm 5\%$, $T_A = -20^\circ C$ to $+70^\circ C$; -40° to $+85^\circ C$)

Parameter	Symbol	Condition	Min	Typ	Max	Units
Output Frequency Range	F_{OUTR}		0.750		1350	MHz
Frequency Stability		Temperature = $-20^\circ C$ to $+70^\circ C$	± 20		± 100	ppm
		Temperature = $-40^\circ C$ to $+85^\circ C$	± 25		± 100	ppm
Aging (1 st year)		$T_a = 25^\circ C$			3	
Aging (10 years)		$T_a = 25^\circ C$			10	
Output Load		To $V_{DD} - 2.0V$		50		Ohms
Start-up Time	T_{ST}	Output valid time after VDD meets minimum specified level			10	ms
Output Rise Time		20% to 80% V_{PP}			400	ps
Output Fall Time		80% to 20% V_{PP}			400	ps
Output Clock Duty Cycle	T_{DTCY}	50% V_{P-P}	45		55	%
Output Enable/ Disable Time	T_{OE}				100	ns
Period Jitter, RMS	J_{PER}	Frequency = 156.25MHz		5.80		ps
Random Jitter	R_J	Frequency = 156.25MHz		1.29		ps
Deterministic Jitter	D_J	Per MJSQ spec (Methodologies for Jitter and Signal Quality specifications)		9.3		ps
Total Jitter	T_J			27.7		ps
Phase Jitter (12kHz – 20MHz)	ϕ_{JITTER}	Common Frequencies		860		fs
Phase Noise Performance Frequency = 156.25MHz	ϕ_{NOISE}	100Hz of Carrier		-80		dBc/Hz
		1kHz of Carrier		-115		dBc/Hz
		10kHz of Carrier		-117		dBc/Hz
		100kHz of Carrier		-121		dBc/Hz
		1MHz of Carrier		-142		dBc/Hz
		10MHz of Carrier		-150		dBc/Hz
Output Frequency (Common)	F_{OUT}	100MHz, 106.25MHz, 125.8MHz, 150MHz, 155.52MHz, 156.25MHz, 200MHz, 212.5MHz, 250MHz, 300MHz, 312.5MHz, 400MHz (Contact IDT for additional frequencies)				

Note: Inclusive of initial frequency accuracy, operating temperature range, supply variation, load variation, 3 times solder reflow, shock, vibration and 1 year aging at 25°C. We do not recommend hand soldering the devices

DC Characteristics

($V_{DD} = 2.5V \pm 5\%$, $T_A = -20^\circ C$ to $+70^\circ C$; -40° to $+85^\circ C$)

Parameter	Symbol	Condition	Min	Typ	Max	Units
Power Supply Current	I_{DD}	Common Frequencies	33		72	mA
Output HIGH Voltage	V_{OH}	Standard LVPECL load		1.40		V
Output LOW Voltage	V_{OL}	Standard LVPECL load		0.68		V
Enable/Disable Input HIGH Voltage (Output enabled)*	V_{IH}		$70\%V_{DD}$			V
Enable/Disable Input LOW Voltage (Output disabled)	V_{IL}				$30\%V_{DD}$	V

* A pullup resistor from pin 6 (VDD) to pin 1 (E/D) enables output when pin 1 is left open.

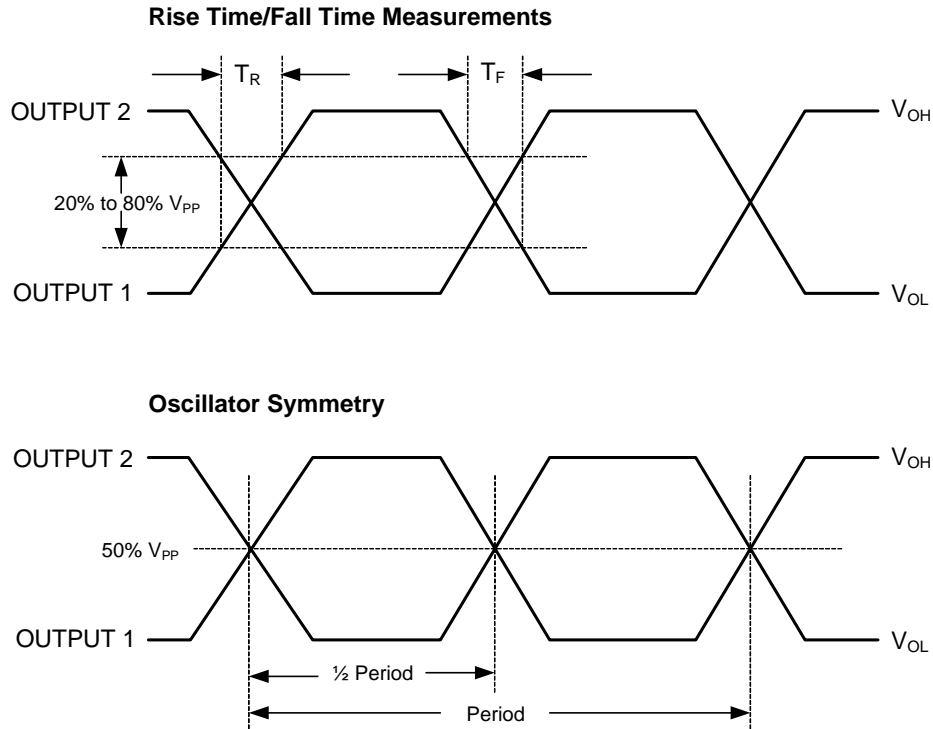
AC Characteristics

($V_{DD} = 2.5V \pm 5\%$, $T_A = -20^\circ C$ to $+70^\circ C$; -40° to $+85^\circ C$)

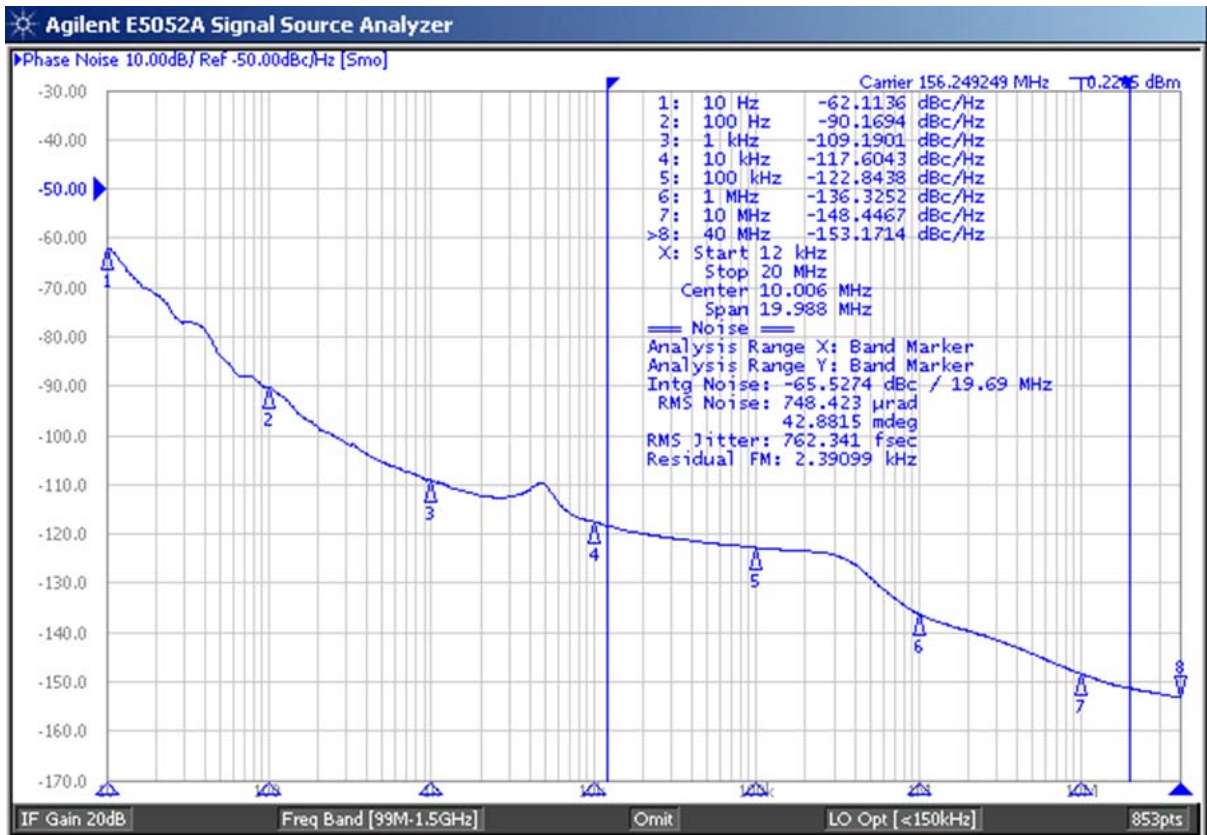
Parameter	Symbol	Condition	Min	Typ	Max	Units
Output Frequency Range	F_{OUTR}		0.750		1000	MHz
Frequency Stability		Temperature = $-20^\circ C$ to $+70^\circ C$	± 20		± 100	ppm
		Temperature = $-40^\circ C$ to $+85^\circ C$	± 25		± 100	ppm
Output Load		To $V_{DD} - 2.0V$		50		Ohms
Start-up Time	T_{ST}	Output valid time after VDD meets minimum specified level			10	ms
Output Rise Time		20% to 80% V_{PP}			400	ps
Output Fall Time		80% to 20% V_{PP}			400	ps
Output Clock Duty Cycle	T_{DTCY}	50% V_{P-P}	45		55	%
Output Enable/ Disable Time	T_{OE}				100	ns
Period Jitter, RMS	J_{PER}	Frequency = 156.25MHz		5.12		ps
Random Jitter	R_J	Frequency = 156.25MHz		1.36		ps
Deterministic Jitter	D_J	Per MJSQ spec (Methodologies for Jitter and Signal Quality specifications)		10.0		ps
Total Jitter	T_J			29.3		ps
Phase Jitter (12kHz – 20MHz)	ϕ_{JITTER}	Frequency = 156.25MHz		1200		fs
Phase Noise Performance Frequency = 156.25MHz	ϕ_{NOISE}	100Hz of Carrier		-83.2		dBc/Hz
		1kHz of Carrier		-106.5		dBc/Hz
		10kHz of Carrier		-115.6		dBc/Hz
		100kHz of Carrier		-120.2		dBc/Hz
		1MHz of Carrier		-136.1		dBc/Hz
		10MHz of Carrier		-145.9		dBc/Hz
Output Frequency (Standards)	F_{OUT}	100MHz, 106.25MHz, 125.8MHz, 150MHz, 155.52MHz, 156.25MHz, 200MHz, 212.5MHz, 250MHz, 300MHz, 312.5MHz, 400MHz (Contact IDT for additional frequencies)				

Note: Inclusive of initial frequency accuracy, operating temperature range, supply variation, load variation, 3 times solder reflow, shock, vibration and 1 year aging at $25^\circ C$. We do not recommend hand soldering the devices

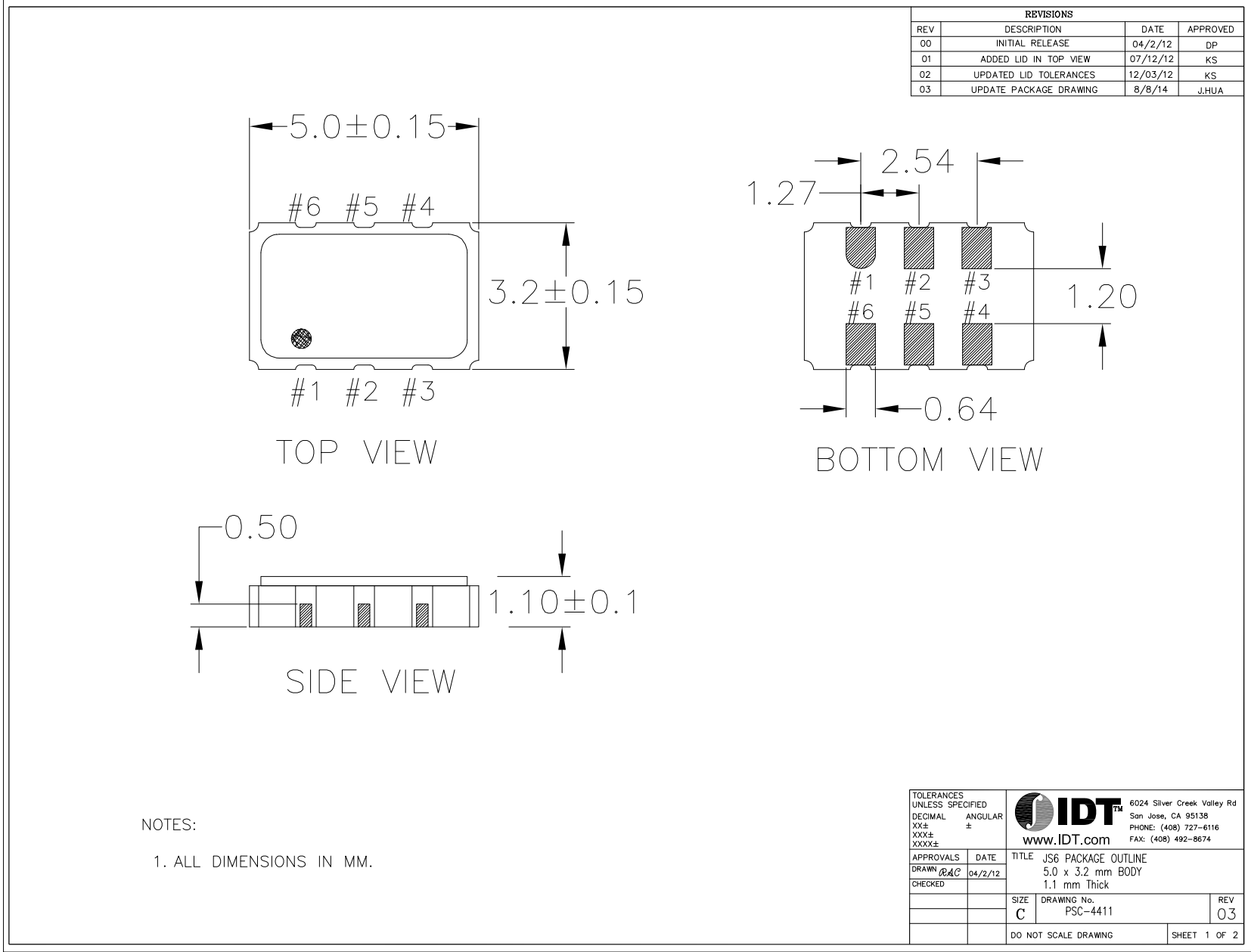
Output Waveform



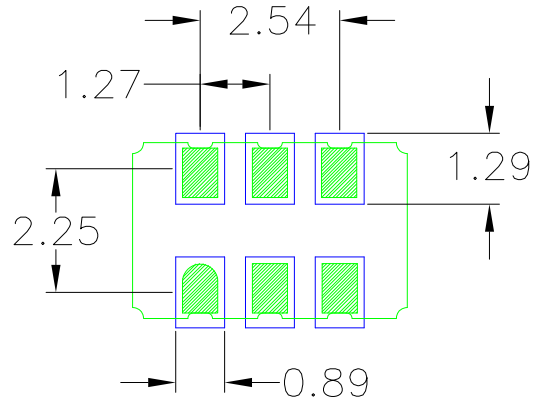
Typical Phase Noise (3.3V)



JS6 Package Outline and Dimensions



JS6 Package Outline and Dimensions (cont.)



RECOMMENDED LAND PATTERN

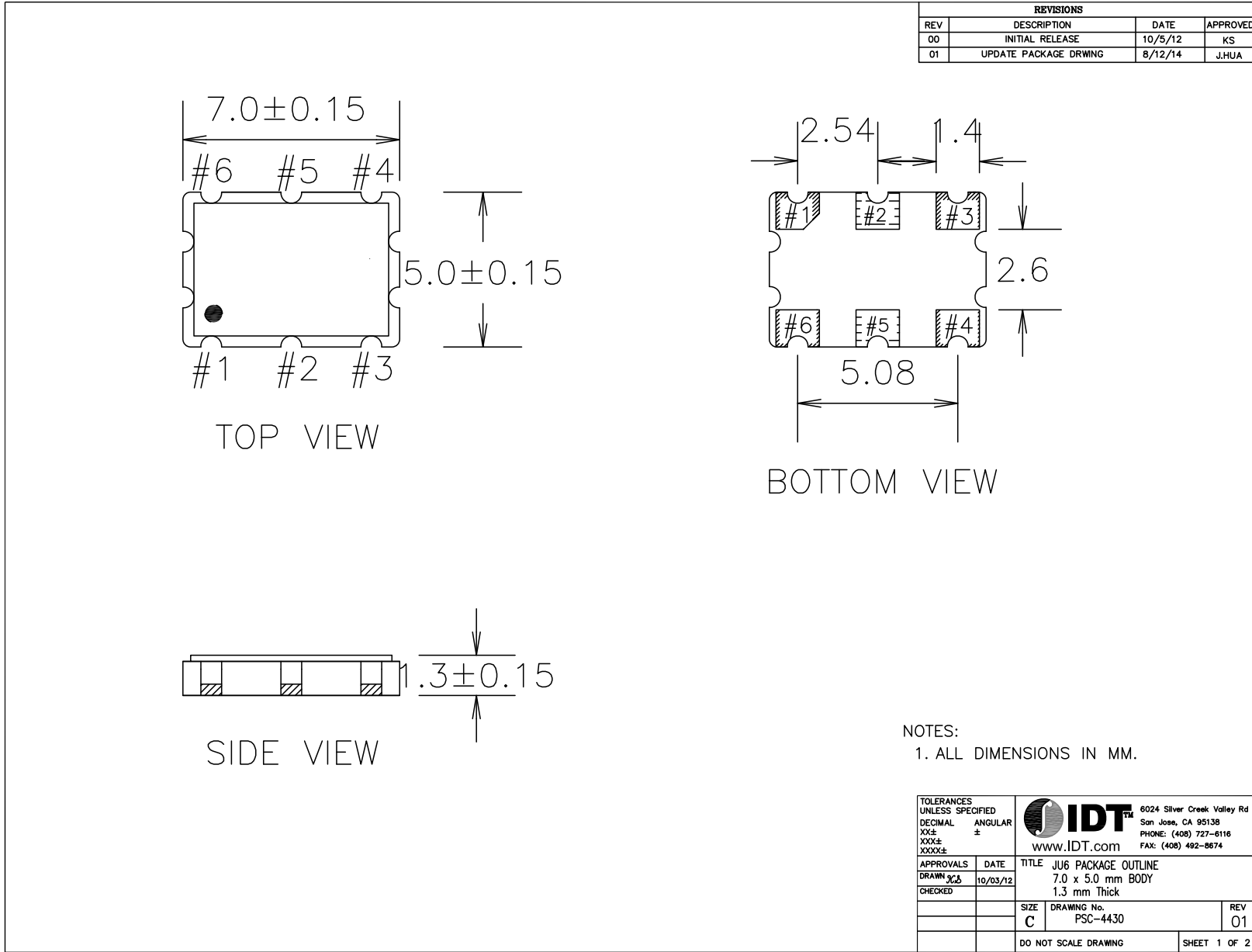
NOTES:

1. ALL DIMENSION ARE IN mm. ANGLES IN DEGREES.
2. TOP DOWN VIEW. AS VIEWED ON PCB.
3. COMPONENT OUTLINE SHOW FOR REFERENCE IN GREEN.
4. LAND PATTERN IN BLUE. NSMD PATTERN ASSUMED.
5. LAND PATTERN RECOMMENDATION PER IPC-7351B GENERIC REQUIREMENT FOR SURFACE MOUNT DESIGN AND LAND PATTERN.

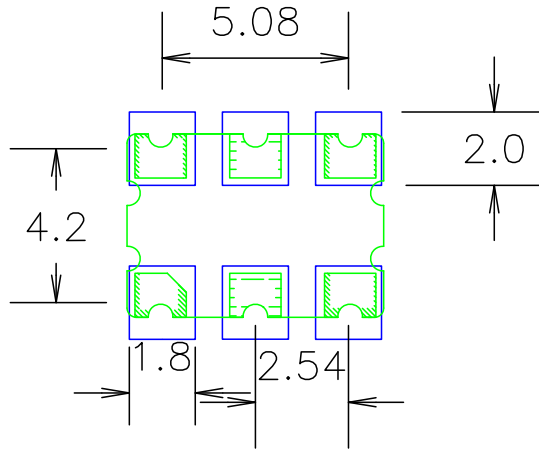
REVISIONS			
REV	DESCRIPTION	DATE	APPROVED
00	INITIAL RELEASE	04/2/12	DP
01	ADDED LID IN TOP VIEW	07/12/12	KS
02	UPDATED LID TOLERANCES	12/03/12	KS
03	UPDATE PACKAGE DRAWING	8/8/14	J.HUA

TOLERANCES UNLESS SPECIFIED		6024 Silver Creek Valley Rd San Jose, CA 95138 www.IDT.com PHONE: (408) 727-6116 FAX: (408) 492-8674
DECIMAL	ANGULAR	
XX±	±	
XXX±		
XXXX±		
APPROVALS	DATE	TITLE
DRAWN <i>pac</i>	04/2/12	JS6 PACKAGE OUTLINE
CHECKED		5.0 x 3.2 mm BODY
		1.1 mm Thick
	SIZE	DRAWING No.
	C	PSC-4411
		REV
		0.3
DO NOT SCALE DRAWING		SHEET 2 OF 2

JU6 Package Outline and Dimensions



JU6 Package Outline and Dimensions (cont.)



RECOMMENDED LAND PATTERN

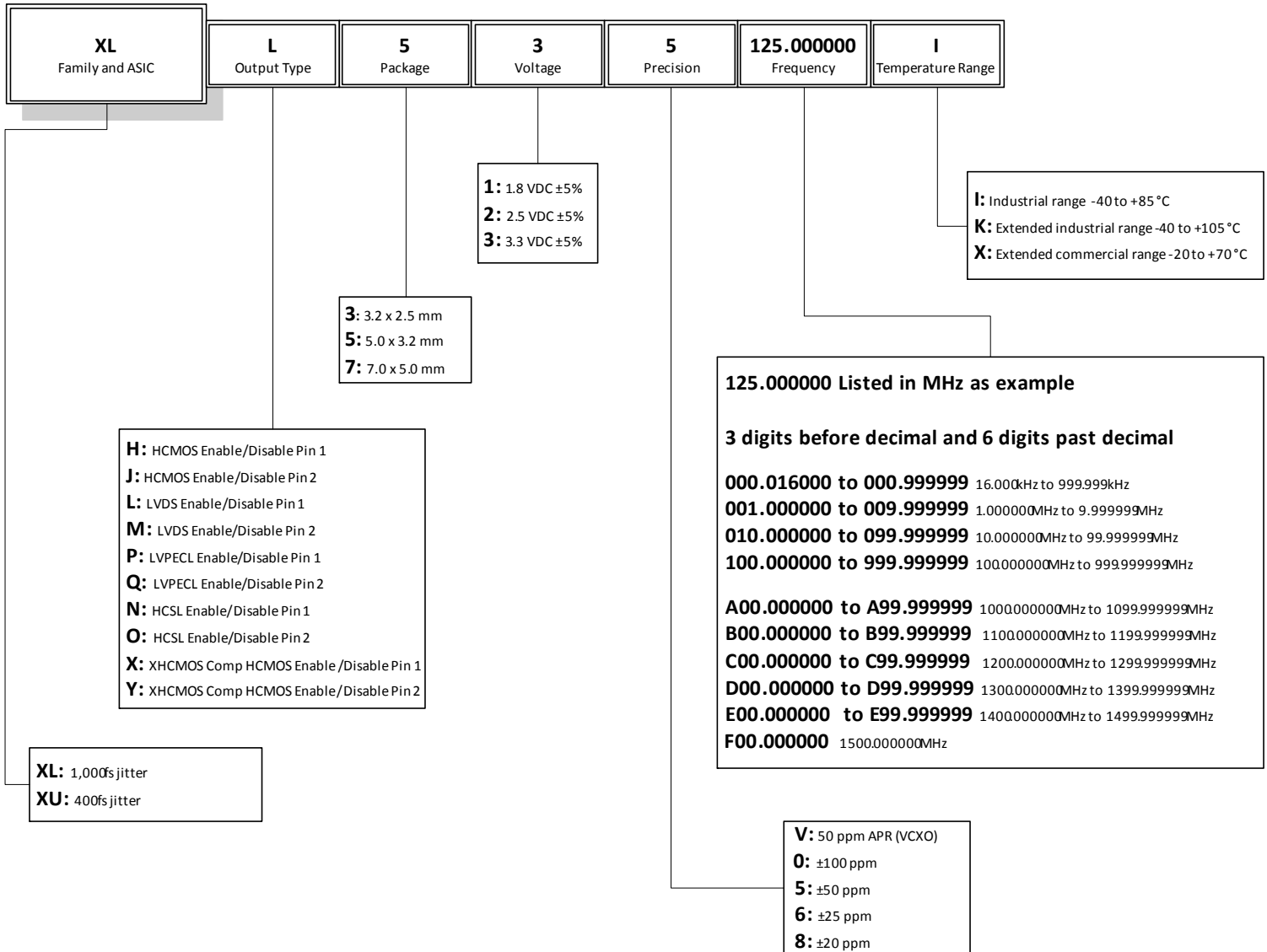
NOTES:

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2. TOP DOWN VIEW. AS VIEWED ON PCB.
3. COMPONENT OUTLINE SHOW FOR REFERENCE IN GREEN.
4. LAND PATTERN IN BLUE. NSMD PATTERN ASSUMED.
5. LAND PATTERN RECOMMENDATION PER IPC-7351B GENERIC REQUIREMENT FOR SURFACE MOUNT DESIGN AND LAND PATTERN.

REVISIONS			
REV	DESCRIPTION	DATE	APPROVED
00	INITIAL RELEASE	10/5/12	KS
01	UPDATE PACKAGE DRWING	8/12/14	J.HUA

TOLERANCES UNLESS SPECIFIED		6024 Silver Creek Valley Rd San Jose, CA 95138 PHONE: (408) 727-6118 FAX: (408) 492-8674 www.IDT.com
DECIMAL	ANGULAR	
XXX±	±	
CHECKED	DATE	TITLE
	10/03/12	JU6 PACKAGE OUTLINE 7.0 x 5.0 mm BODY 1.3 mm Thick
SIZE	DRAWING No.	REV
C	PSC-4430	01
DO NOT SCALE DRAWING		SHEET 2 OF 2

IDT Ordering Information



Revision History

Date	Originator	Description of Change
10/17/14	B. Chandhoke	Initial release.
12/10/14	B. Chandhoke	1. Added 7 x 5 x 1.3mm JU6 package option and package dimension/landing pattern drawings. 2. Updated ordering information table/graphic to show JU6 package option.
10/28/16	P. Jenkins	Update ordering information decoder tables by separating them into Scheme 1 and Scheme 2; add note to distinguish the two tables.
06/13/17	L.S.	Removed "Ordering Information Scheme #1 (for reference only)". Replaced with a single ordering information table.
06/20/17	L.S.	Corrected frequency errors in Ordering Information table.



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